Panasonic

MAZF000 Series

Silicon planer type

Surge absorption circuit

■ Features

- S-Mini type package (2-pin)
- No rank classification (V_Z = 3.3 to 12V)

■ Absolute Maximum Ratings (Ta= 25°C)

Parameter	Symbol	Rating	Unit
Average forward current	I _{F(AV)}	100	mA
Instanious forward current	I _{FRM}	200	mA
Total power dissipation	P _{tot} *	150	mW
Junction temperature	T_j	150	°C
Storage temperature	T _{stg}	- 55 to +150	°C N

^{*} With a printed-circuit board

Cathode Anode Cathode Anode Cathode Anode Cathode Anode Cathode Cathode Cathode Anode Cathode Anode Cathode S-Mini Type Package (2-pin)

■ Common Electrical Characteristics (Ta= 25°C)*1

Parameter		Symbol	Condition	min	typ	max	Unit
Forward voltage		V _F	I _F = 15mA		0.9	1.0	V
Zener voltage		Vz* 2	I _Z Specified value —	450			V
Operating resistance		$R_{\rm Z}$	R _Z I _Z Specified value Refer to the electrical characteristics				
Reverse current		I_R	V _R Specified value list of P483				μA
Terminal capacitance	~C _O ,	C_t	V _R Specified value				pF

Note 1. Test method: Depend on JIS C7031 testing

^{2.} Rated input/output frequency: 5MHz

^{3. *} 1 : The V_{Z} value is for the temperature of 25°C. In other cases, carry out the temperature compensation.

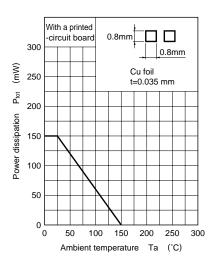
^{*} 2 : Guaranteeed at 20ms after power application

Zener Diodes MAZF000 Series

■ Electrical Characteristics (Ta= 25°C)

		Zener voltage			Reverse current		Operating resis-		Terminal capaci-	
Do at Moundo an		***					tance		tance	Marking
Part Number	V_Z			I _R		R _Z		$C_t(pF)$ $(V_R=0V)$		
	min	nom	max	I_Z	max	V_R	max	I_Z	f=1MHz	
	(V)	(V)	(V)	(mA)	(µA)	(V)	(Ω)	(mA)	typ	
MAZF033	3.10	3.30	3.50	5	20	1.0	130	5	325	B1
MAZF036	3.40	3.60	3.80	5	10	1.0	130	5	300	B2
MAZF039	3.70	3.90	4.10	5	10	1.0	130	5	300	В3
MAZF043	4.00	4.30	4.60	5	10	1.0	130	5	275	C1
MAZF047	4.40	4.70	5.00	5	2.0	1.0	80	5	130	C2
MAZF051	4.80	5.10	5.40	5	1.0	2.0	60	5	110	D1
MAZF056	5.30	5.60	6.00	5	0.5	2.5	40	5	95	D2
MAZF062	5.80	6.20	6.60	5	0.2	4.0	30	5	90	E1
MAZF068	6.40	6.80	7.20	5	0.1	4.0	20	5	85	E2
MAZF075	7.00	7.50	7.90	5	0.1	5.0	20	5	80	F
MAZF082	7.70	8.20	8.70	5	0.1	5.0	20	5	75	G
MAZF091	8.50	9.10	9.60	5	0.1	6.0	20	5	70	Н
MAZF100	9.40	10.00	10.60	5	0.05	7.0	30	5	70	10
MAZF110	10.40	11.00	11.60	5	0.05	8.0	30	5	65	11
MAZF120	11.40	12.00	12.70	5	0.05	9.0	30	5	65	12





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